Vincotech

10-FZ076PA050I7-P865F08
datasheet

***flow*PACK 0** **650 V / 50 A**

Topology features

- Inverter
- Kelvin Emitter for improved switching performance
- Temperature sensor

Component features

- Easy paralleling
- Low collector emitter saturation voltage
- Low turn-off losses
- Positive temperature coefficient

Housing features

- Base isolation: Al_2O_3
- Clip-in, reliable mechanical connection, qualified for wave soldering
- Convex shaped substrate for superior thermal contact
- Thermo-mechanical push-and-pull force relief
- Solder pin

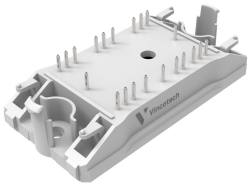
Target applications

- General Purpose Drives
- Heat Pumps
- Industrial Drives

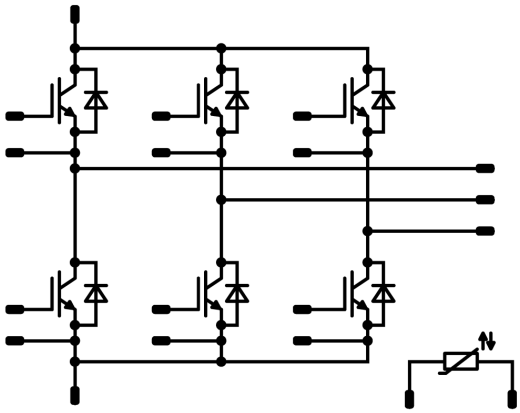
Types

- 10-FZ076PA050I7-P865F08

flow 0 12 mm housing



Schematic



Maximum Ratings

T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ T_s = 80 °C	49	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Turn off safe operating area		T_j = 150°C, V_{CE} = 1200 V	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ T_s = 80 °C	78	W
Gate-emitter voltage	V_{GES}		±20	V
Short circuit ratings	t_{SC}	V_{GE} = 15 V, V_{CC} = 400 V T_j = 150 °C	3	µs
Maximum junction temperature	T_{jmax}		175	°C
Inverter Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ T_s = 80 °C	40	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ T_s = 80 °C	63	W
Maximum junction temperature	T_{jmax}		175	°C
Module Properties				
Thermal Properties				
Storage temperature	T_{stg}		-40…+125	°C
Operation temperature under switching condition	T_{jop}		-40…+(T_{jmax} - 25)	°C
Isolation Properties				
Isolation voltage	V_{isol}	DC Test Voltage* t_p = 2 s	6000	V
Creepage distance			>12,7	mm
Clearance			9,1	mm
Comparative Tracking Index	CTI		≥ 200	

*100 % tested in production

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Inverter Switch										
Static										
Gate-emitter threshold voltage	$V_{GE(th)}$	V_{CE} = V_{GE}			0,0005	25	4,35	5	5,65	V
Collector-emitter saturation voltage	V_{CEsat}		15		50	25 125 150		1,43 1,54 1,57	1,65(1)	V
Collector-emitter cut-off current	I_{CES}		0	650		25			20	µA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	f = 1 Mhz	0	25		25		3050		pF
Output capacitance	C_{oes}							92		pF
Reverse transfer capacitance	C_{res}							31		pF
Gate charge	Q_g	V_{CC} = 520 V	15		50	25		290		nC
Thermal										
Thermal resistance junction to sink(2)	$R_{th(j-s)}$	λ_{paste} = 5,2 W/mK (PTM)						1,22		K/W
Dynamic										
Turn-on delay time	$t_{d(on)}$	R_{gon} = 4 Ω R_{goff} = 4 Ω	±15	350	60	25 125 150		60,22 63,85 64,79		ns
Rise time	t_r					25 125 150		21,2 23,48 23,96		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		114,14 139,21 145,94		ns
Fall time	t_f					25 125 150		24,95 45,38 49,96		ns
Turn-on energy (per pulse)	E_{on}	Q_{rFWD}=0,987 µC Q_{rFWD}=2,1 µC Q_{rFWD}=2,46 µC				25 125 150		1,03 1,39 1,47		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,911 1,32 1,41		mWs

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Inverter Diode										
Static										
Forward voltage	V_F				50	25 125 150		1,82 1,74 1,69	2[1]	V
Reverse leakage current	I_R	V_r = 650 V				25			20	µA
Thermal										
Thermal resistance junction to sink[2]	$R_{th(j-s)}$	λ_{paste} = 5,2 W/mK (PTM)						1,52		K/W
Dynamic										
Peak recovery current	I_{RM}	di/dt=1771 A/µs di/dt=2798 A/µs di/dt=2805 A/µs	±15	350	60	25 125 150		20,58 29,39 32,05		A
Reverse recovery time	t_{rr}					25 125 150		81,61 119,04 131,06		ns
Recovered charge	Q_r					25 125 150		0,987 2,1 2,46		µC
Reverse recovered energy	E_{rec}					25 125 150		0,201 0,446 0,527		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		285,34 455,98 372,9		A/µs

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Thermistor										
Static										
Rated resistance	R					25		22		kΩ
Deviation of R100	$\Delta_{R/R}$	R_{100} = 1484 Ω				100	-5		5	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

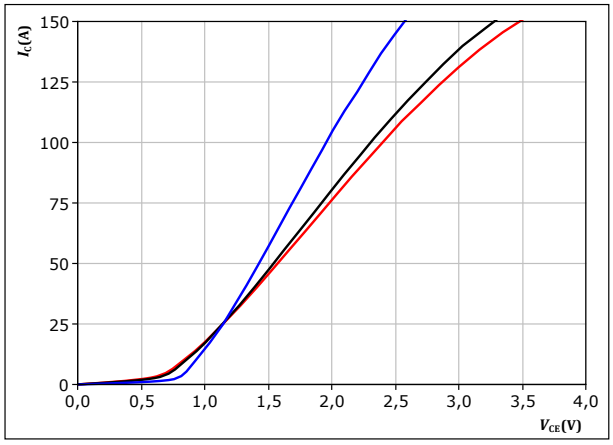
(1) Value at chip level
(2) Only valid with pre-applied Vincotech thermal interface material.

Inverter Switch Characteristics

figure 1. **IGBT**

Typical output characteristics

$I_C = f(V_{CE})$

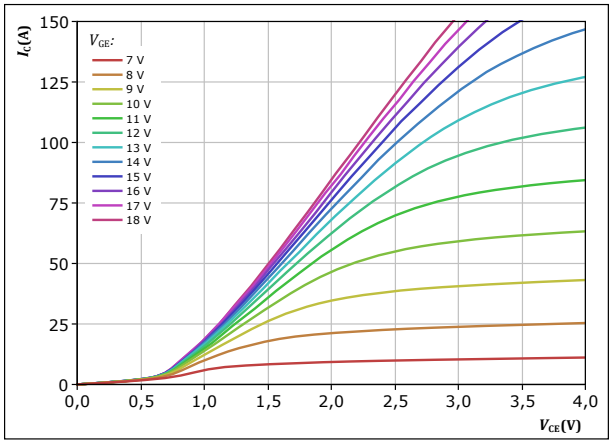


t_p =	250	µs		
V_{GE} =	15	V	T_j:	25 °C
				125 °C
				150 °C

figure 2. **IGBT**

Typical output characteristics

$I_C = f(V_{CE})$



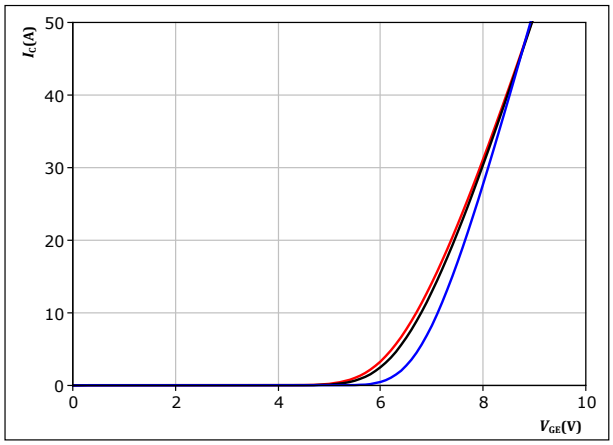
t_p =	250	µs
T_j =	150	°C

V_{GE} from 7 V to 18 V in steps of 1 V

figure 3. **IGBT**

Typical transfer characteristics

$I_C = f(V_{GE})$

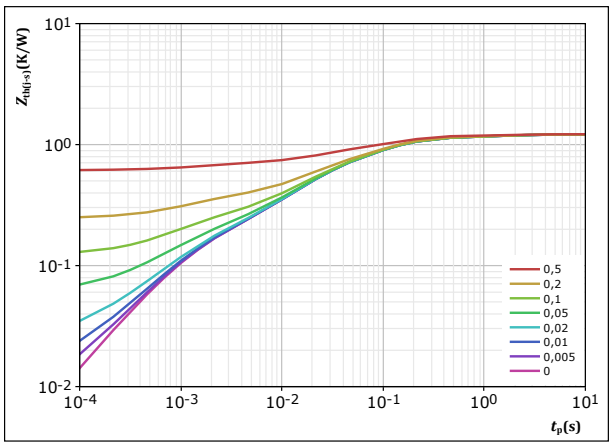


t_p =	250	µs		
V_{CE} =	30	V	T_j:	25 °C
				125 °C
				150 °C

figure 4. **IGBT**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



D =	t_p / T	
$R_{th(j-s)}$ =	1,218	K/W

IGBT thermal model values

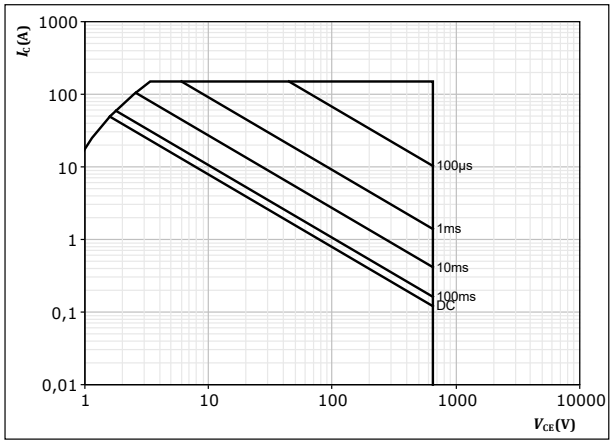
R (K/W)	τ (s)
1,40E-02	7,38E+01
9,43E-02	1,28E+00
5,98E-01	1,01E-01
3,90E-01	1,80E-02
1,28E-01	1,07E-03

Inverter Switch Characteristics

figure 5. **IGBT**

Safe operating area

$I_C = f(V_{CE})$

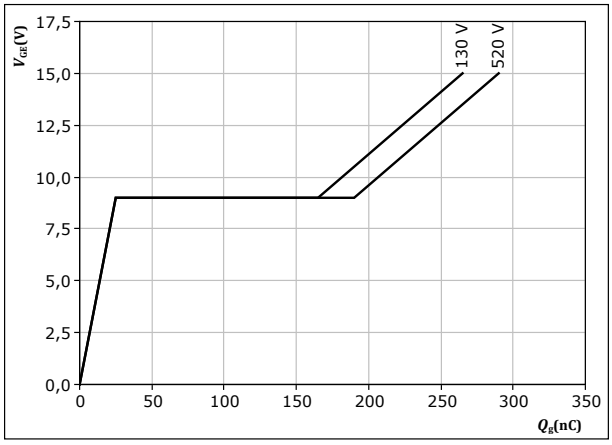


D =	single pulse	
T_s =	80	°C
V_{GE} =	15	V
T_j =	T_{jmax}	

figure 6. **IGBT**

Gate voltage vs gate charge

$V_{GE} = f(Q_g)$



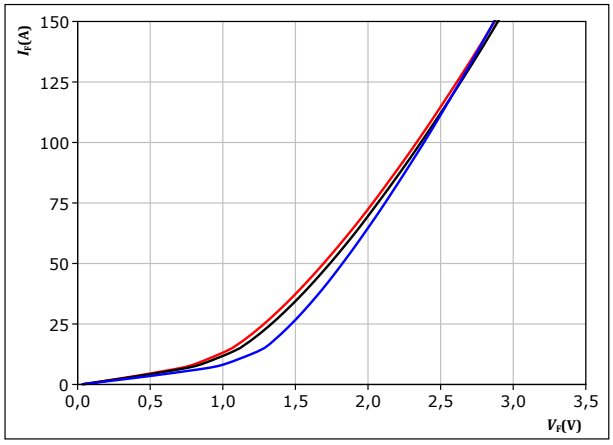
I_C =	50	A
T_j =	25	°C

Inverter Diode Characteristics

figure 7. **FWD**

Typical forward characteristics

$I_F = f(V_F)$



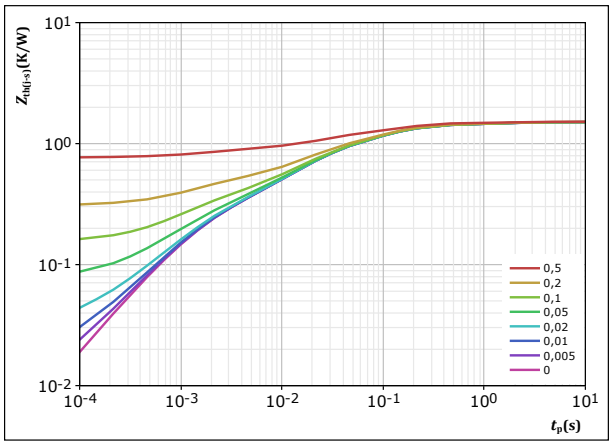
t_p = 250 µs

T_j: 25 °C, 125 °C, 150 °C

figure 8. **FWD**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



D = t_p / T

$R_{th(j-s)}$ = 1,517 K/W

FWD thermal model values

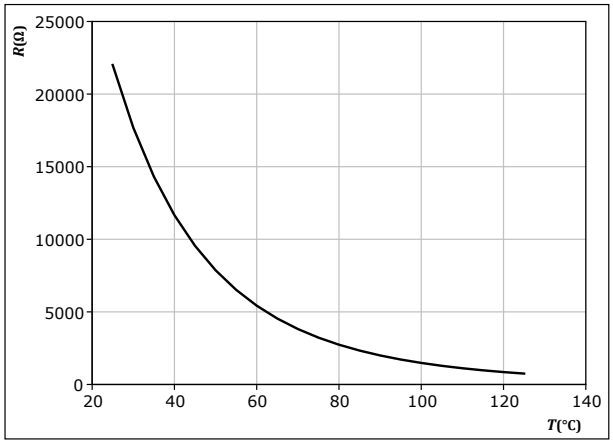
R (K/W)	τ (s)
2,74E-02	1,37E+02
9,92E-02	1,32E+00
6,55E-01	1,03E-01
5,46E-01	1,70E-02
2,03E-01	1,30E-03

Thermistor Characteristics

figure 9. **Thermistor**

Typical NTC characteristic as function of temperature

$R_T = f(T)$

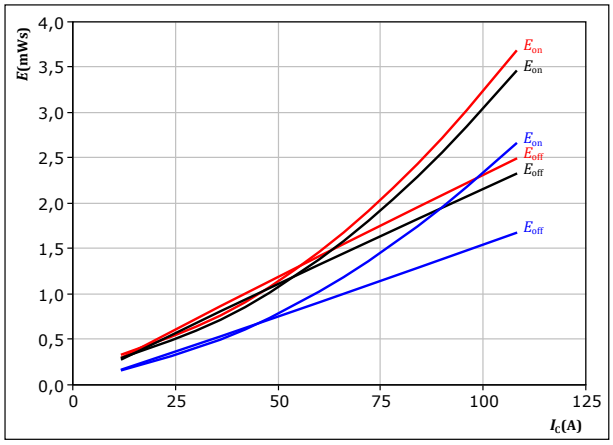


Inverter Switching Characteristics

figure 10. **IGBT**

Typical switching energy losses as a function of collector current

$E = f(I_C)$



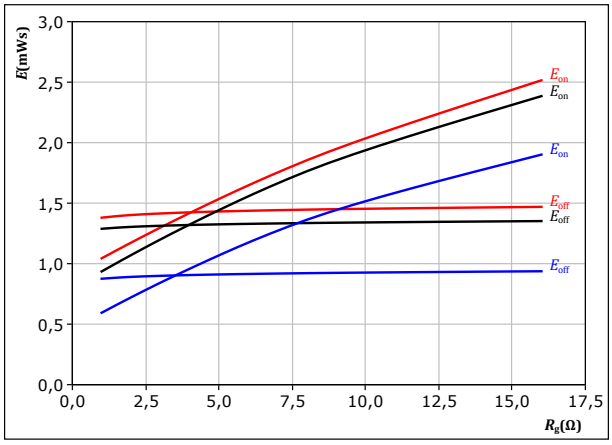
With an inductive load at

V_{CE} =	350	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
R_{gon} =	4	Ω		150 °C
R_{goff} =	4	Ω		

figure 11. **IGBT**

Typical switching energy losses as a function of IGBT turn on gate resistor

$E = f(R_g)$



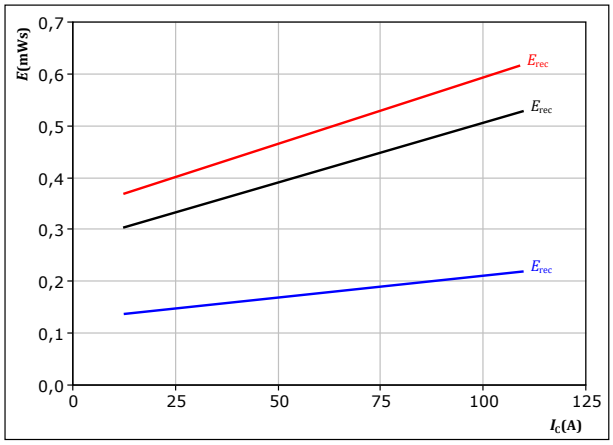
With an inductive load at

V_{CE} =	350	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
I_C =	60	A		150 °C

figure 12. **FWD**

Typical reverse recovered energy loss as a function of collector current

$E_{rec} = f(I_C)$



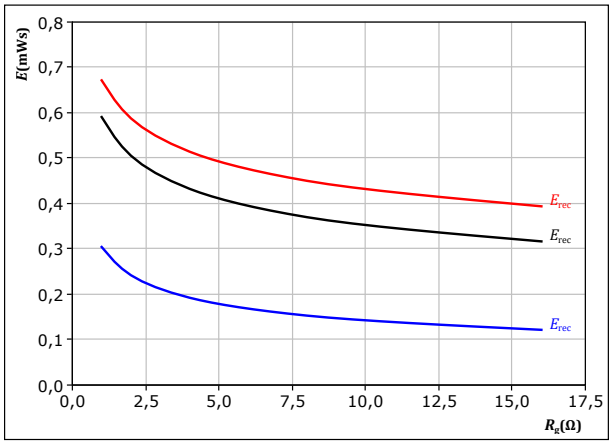
With an inductive load at

V_{CE} =	350	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
R_{gon} =	4	Ω		150 °C

figure 13. **FWD**

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$E_{rec} = f(R_g)$



With an inductive load at

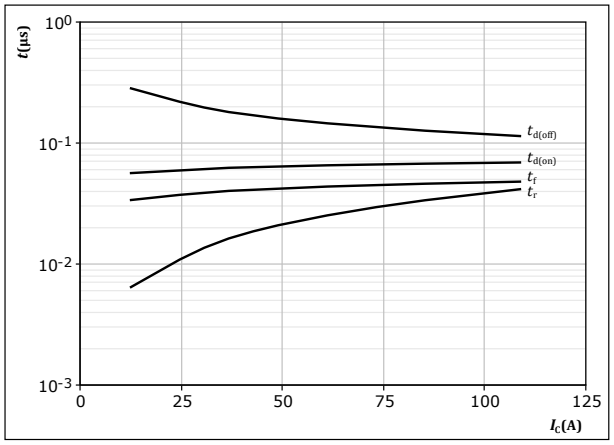
V_{CE} =	350	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
I_C =	60	A		150 °C

Inverter Switching Characteristics

figure 14. **IGBT**

Typical switching times as a function of collector current

t = f(I_C)



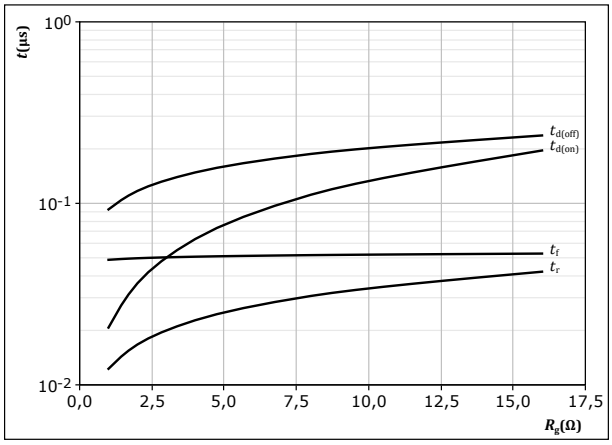
With an inductive load at

T_j =	150	°C
V_{CE} =	350	V
V_{GE} =	±15	V
R_{gon} =	4	Ω
R_{goff} =	4	Ω

figure 15. **IGBT**

Typical switching times as a function of IGBT turn on gate resistor

t = f(R_g)



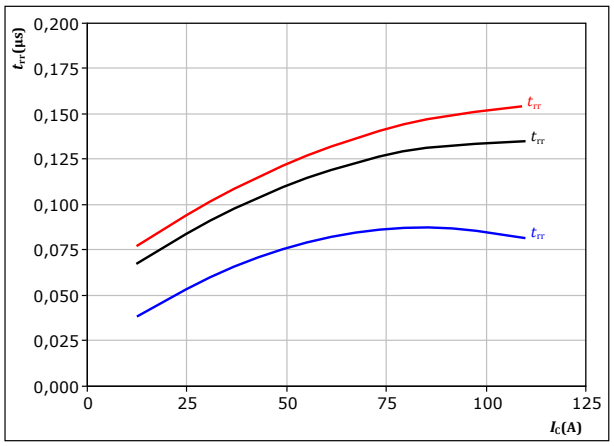
With an inductive load at

T_j =	150	°C
V_{CE} =	350	V
V_{GE} =	±15	V
I_C =	60	A

figure 16. **FWD**

Typical reverse recovery time as a function of collector current

t_{rr} = f(I_C)



With an inductive load at

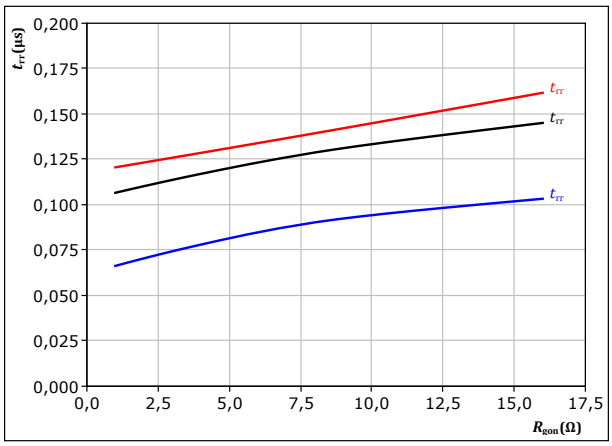
V_{CE} =	350	V
V_{GE} =	±15	V
R_{gon} =	4	Ω

T_j: 25 °C, 125 °C, 150 °C

figure 17. **FWD**

Typical reverse recovery time as a function of IGBT turn on gate resistor

t_{rr} = f(R_{gon})



With an inductive load at

V_{CE} =	350	V
V_{GE} =	±15	V
I_C =	60	A

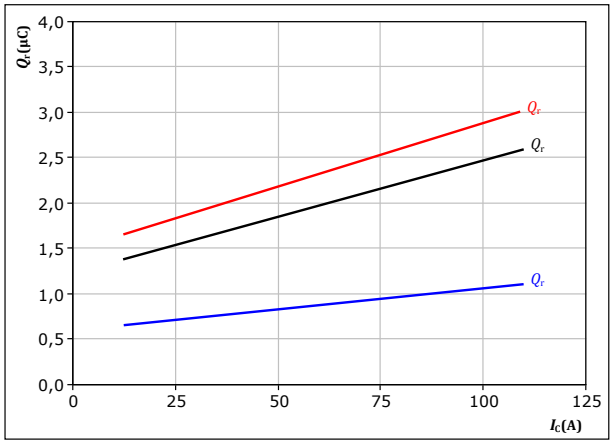
T_j: 25 °C, 125 °C, 150 °C

Inverter Switching Characteristics

figure 18. **FWD**

Typical recovered charge as a function of collector current

$Q_r = f(I_C)$



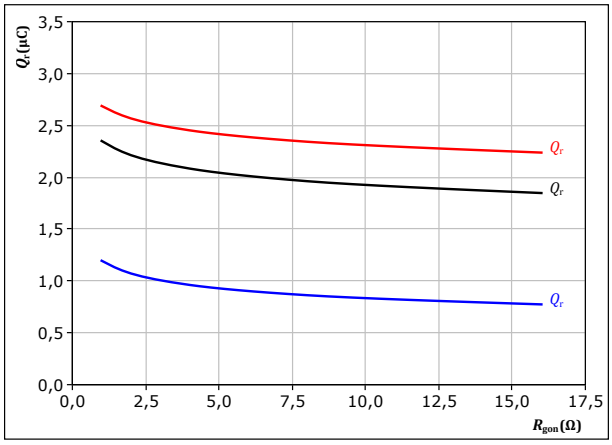
With an inductive load at

V_{CE} =	350	V	T_j: 25 °C
V_{GE} =	±15	V	125 °C
R_{gon} =	4	Ω	150 °C

figure 19. **FWD**

Typical recovered charge as a function of IGBT turn on gate resistor

$Q_r = f(R_{gon})$



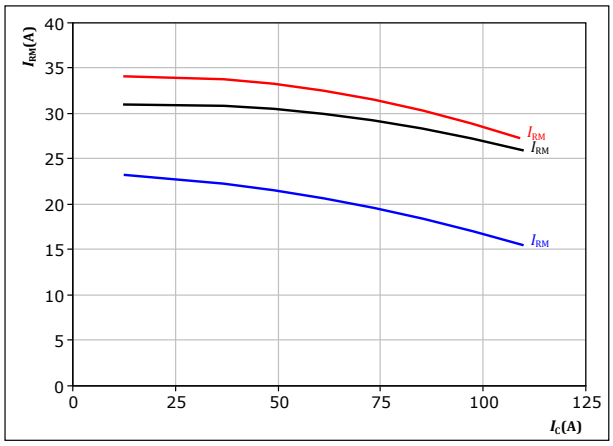
With an inductive load at

V_{CE} =	350	V	T_j: 25 °C
V_{GE} =	±15	V	125 °C
I_C =	60	A	150 °C

figure 20. **FWD**

Typical peak reverse recovery current as a function of collector current

$I_{RM} = f(I_C)$



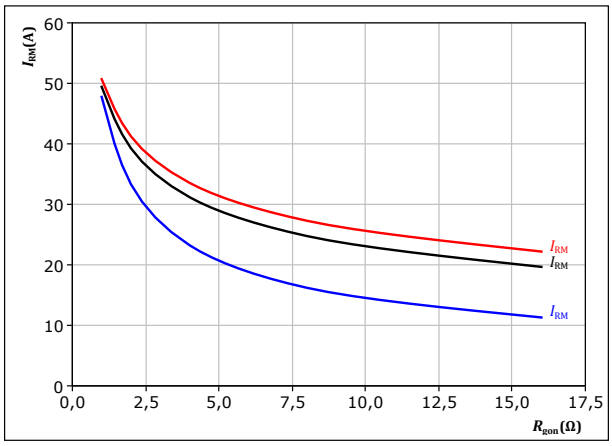
With an inductive load at

V_{CE} =	350	V	T_j: 25 °C
V_{GE} =	±15	V	125 °C
R_{gon} =	4	Ω	150 °C

figure 21. **FWD**

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$I_{RM} = f(R_{gon})$



With an inductive load at

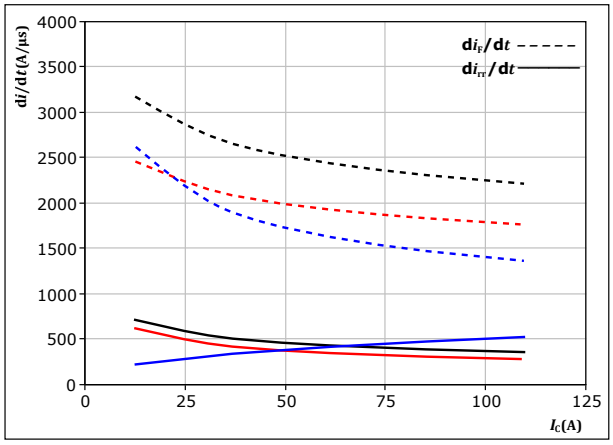
V_{CE} =	350	V	T_j: 25 °C
V_{GE} =	±15	V	125 °C
I_C =	60	A	150 °C

Inverter Switching Characteristics

figure 22. **FWD**

Typical rate of fall of forward and reverse recovery current as a function of collector current

di_F/dt, di_{rr}/dt = f(I_C)



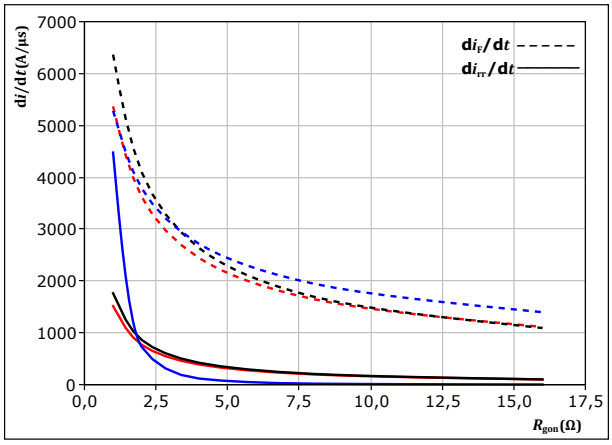
With an inductive load at

V_{CE} =	350	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
R_{gon} =	4	Ω		150 °C

figure 23. **FWD**

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor

di_F/dt, di_{rr}/dt = f(R_{gon})



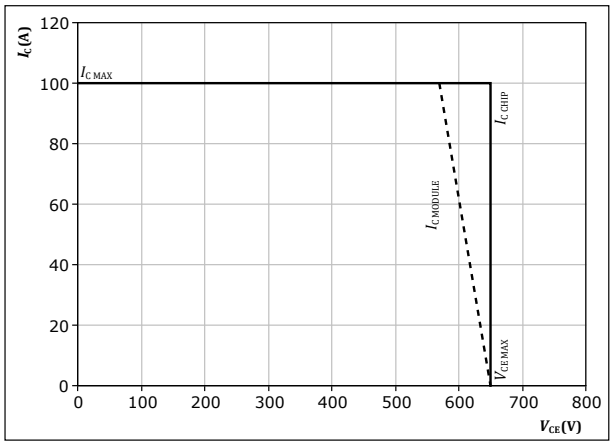
With an inductive load at

V_{CE} =	350	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
I_C =	60	A		150 °C

figure 24. **IGBT**

Reverse bias safe operating area

I_C = f(V_{CE})



At

T_j =	150	°C	
R_{gon} =	4	Ω	
R_{goff} =	4	Ω	

Inverter Switching Definitions

figure 25. **IGBT**

Turn-off Switching Waveforms & definition of t_{doff}, t_{Eoff} (t_{tEoff} = integrating time for E_{off})

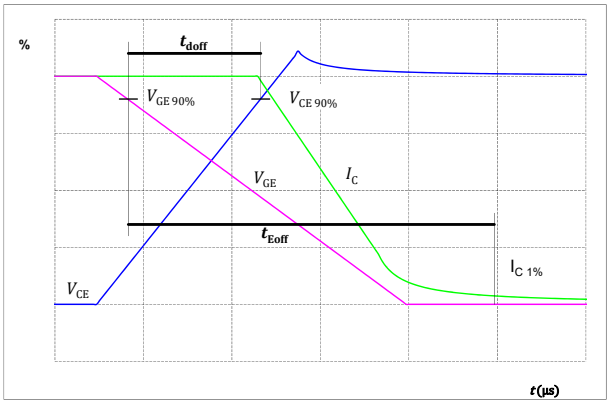


figure 26. **IGBT**

Turn-on Switching Waveforms & definition of t_{don}, t_{Eon} (t_{Eon} = integrating time for E_{on})

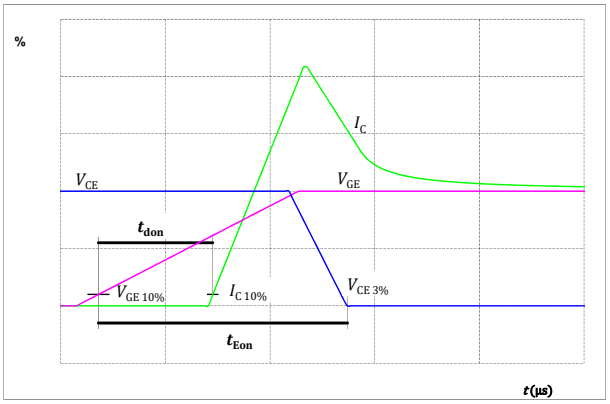


figure 27. **IGBT**

Turn-off Switching Waveforms & definition of t_f

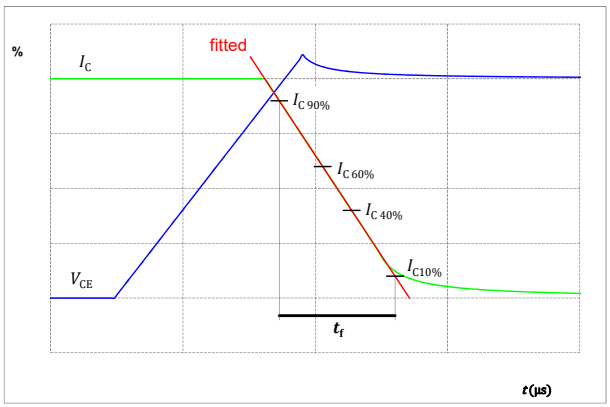
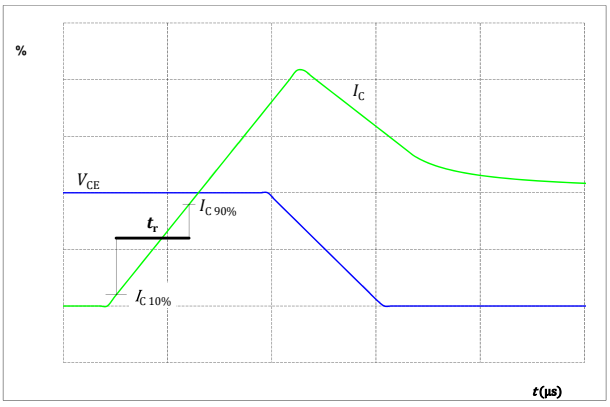


figure 28. **IGBT**

Turn-on Switching Waveforms & definition of t_r



Inverter Switching Definitions

figure 29. **FWD**

Turn-off Switching Waveforms & definition of t_{rr}

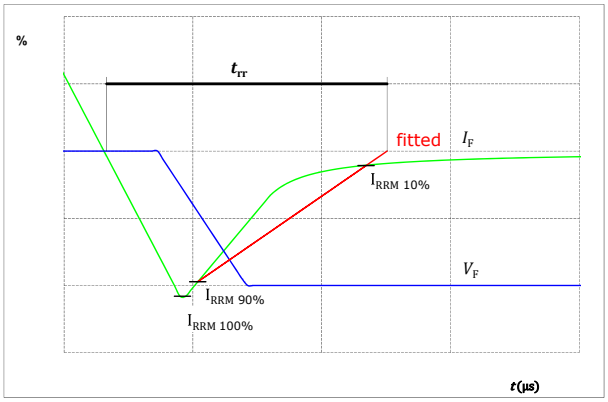
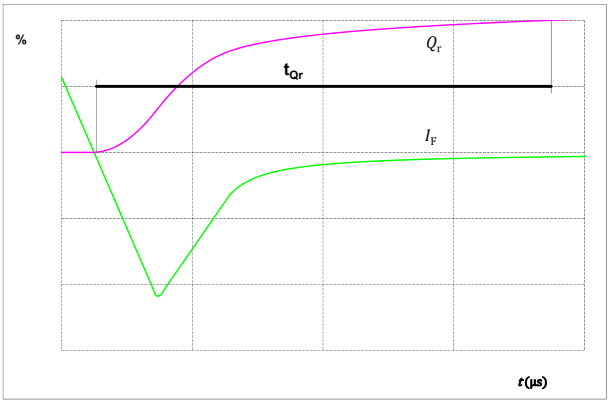


figure 30. **FWD**

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)



Ordering Code

Version	Ordering Code
Without thermal paste	10-FZ076PA050I7-P865F08
With thermal paste (5,2 W/mK, PTM6000HV)	10-FZ076PA050I7-P865F08-/7/

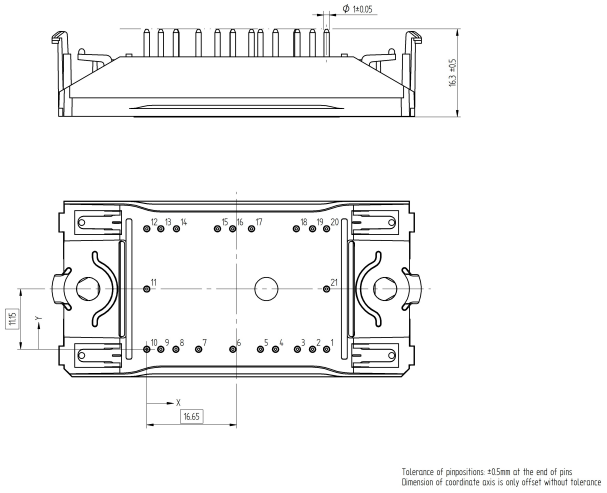
Marking

	Name		Date code	UL & VIN	Lot	Serial
Text	NN-NNNNNNNNNNNNNN-TTTTTTVV		WWYY	UL VIN	LLLLL	SSSS
Datamatrix	**Type&Ver**	**Lot number**	**Serial**	**Date code**		
	TTTTTTVV	LLLLL	SSSS	WWYY		

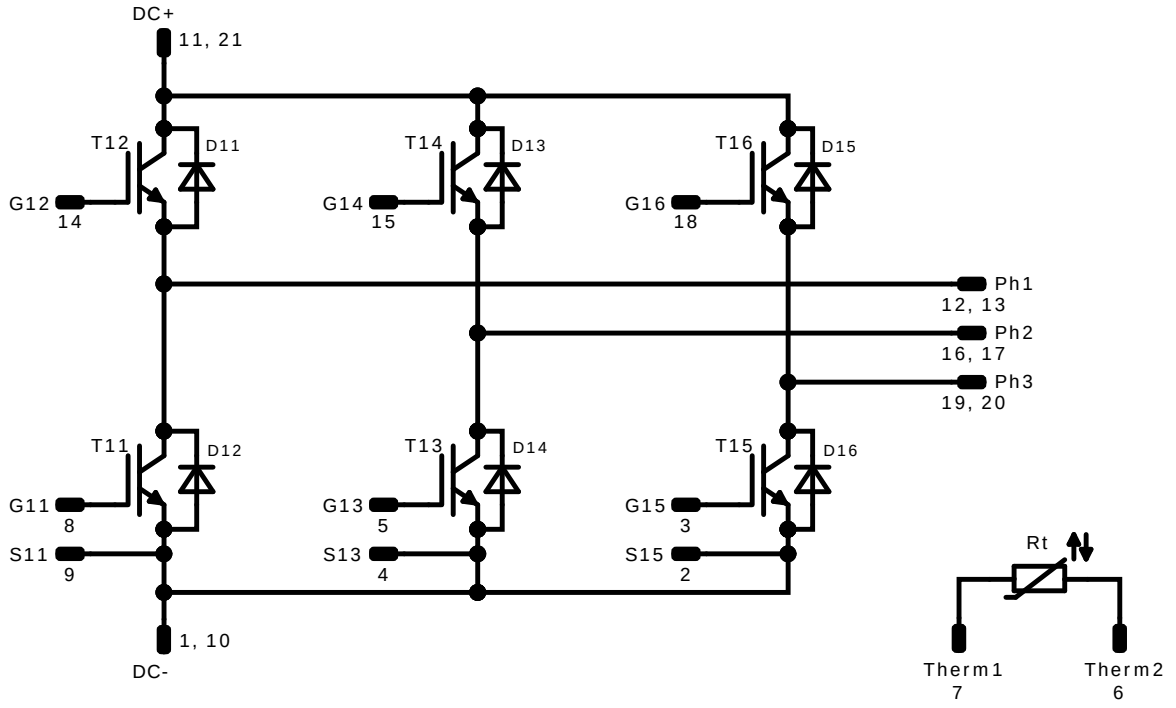
Outline

Pin table [mm]

Pin	X	Y	Function
1	33,3	0	DC-
2	30,7	0	S15
3	27,9	0	G15
4	23,85	0	S13
5	21,05	0	G13
6	15,95	0	Therm2
7	9,6	0	Therm1
8	5,4	0	G11
9	2,6	0	S11
10	0	0	DC-
11	0	11,15	DC+
12	0	22,3	Ph1
13	2,6	22,3	Ph1
14	5,5	22,3	G12
15	13,1	22,3	G14
16	15,9	22,3	Ph2
17	19,4	22,3	Ph2
18	27,7	22,3	G16
19	30,7	22,3	Ph3
20	33,3	22,3	Ph3
21	33,3	11,15	DC+



Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	650 V	50 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	650 V	50 A	Inverter Diode	
Rt	Thermistor			Thermistor	

Packaging instruction				
Standard packaging quantity (SPQ) 135	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for *flow* 0 packages see vincotech.com website.

Package data
Package data for *flow* 0 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is UL 1557 recognized under E192116 up to a junction temperature under switching condition $T_{j,op}$=175°C and up to 3500VAC/1min isolation voltage. For more information see vincotech.com website.

Document No.:	Date:	Modification:	Pages
10-FZ076PA050I7-P865F08-D1-14	22 Jan. 2026	Initial Release	